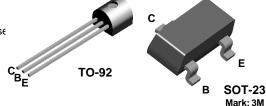


### 2N5210/MMBT5210

#### **NPN General Purpose Amplifier**

This device is designed for low noise, high gain, general purpose amplifier applications at collector currents from 1µA to 50 mA.



#### **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	50	V
V <sub>CBO</sub>	Collector-Base Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	4.5	V
I <sub>C</sub>	Collector Current - Continuous	100	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Ма	Units	
Cyllibol	Onal actoristic	2N5210	MMBT5210	Oilles
$P_{D}$	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

<sup>1)</sup> These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# NPN General Purpose Amplifier (continued)

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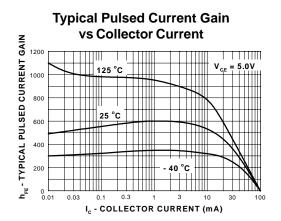
Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = 1.0 \text{ mA}, I_B = 0$	50		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 0.1 \text{ mA}, I_E = 0$	50		V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 35 \text{ V}, I_{E} = 0$		50	nA
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 3.0 \text{ V}, I_{C} = 0$		50	nA
ON CHAR	ACTERISTICS				
	RACTERISTICS DC Current Gain	I <sub>C</sub> = 100 μA, V <sub>CE</sub> = 5.0 V	200	600	
		$I_C = 100 \mu A, V_{CE} = 5.0 \text{ V}$ $I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$	200 250 250	600	
h <sub>FE</sub>		$I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$	250	600	V
$V_{CE(sat)}$	DC Current Gain	$I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}^*$	250		V
$V_{CE(sat)}$	DC Current Gain  Collector-Emitter Saturation Voltage	$\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 5.0 \text{ V} \\ I_C &= 10 \text{ mA}, \ V_{CE} = 5.0 \text{ V}^* \\ I_C &= 10 \text{ mA}, \ I_B = 1.0 \text{ mA} \end{split}$	250	0.7	
$\begin{array}{c} h_{FE} \\ V_{CE(sat)} \\ V_{BE(on)} \end{array}$	DC Current Gain  Collector-Emitter Saturation Voltage	$\begin{split} I_C &= 1.0 \text{ mA}, \ V_{CE} = 5.0 \text{ V} \\ I_C &= 10 \text{ mA}, \ V_{CE} = 5.0 \text{ V}^* \\ I_C &= 10 \text{ mA}, \ I_B = 1.0 \text{ mA} \end{split}$	250	0.7	

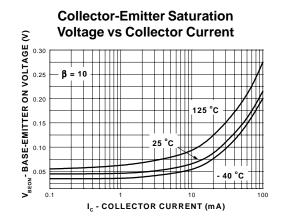
f⊤	Current Gain - Bandwidth Product	$I_{C} = 500 \mu\text{A}, V_{CE} = 5.0 \text{V},$ f = 20 MHz	30		MHz
C <sub>cb</sub>	Collector-Base Capacitance	$V_{CB} = 5.0 \text{ V}, I_E = 0, f = 100 \text{ kHz}$		4.0	pF
h <sub>fe</sub>	Small-Signal Current Gain	$I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 1.0  kHz	250	900	
NF	Noise Figure	$I_C = 20 \mu A$ , $V_{CE} = 5.0 V$ , $R_S = 22 k\Omega$ , $f = 10 Hz$ to 15.7 kHz		2.0	dB
		$I_C = 20 \mu A$ , $V_{CE} = 5.0 \text{ V}$ , $R_S = 10 \text{ k}\Omega$ , $f = 1.0 \text{ kHz}$		3.0	dB

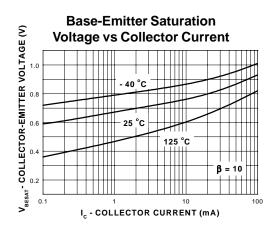
<sup>\*</sup>Pulse Test: Pulse Width  $\leq\!300\,\mu\text{s},\,\text{Duty Cycle}\,\leq\!2.0\%$ 

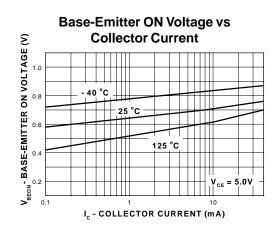
(continued)

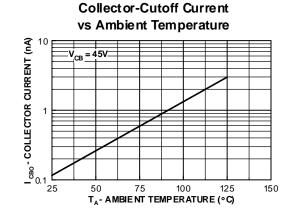
#### **Typical Characteristics**







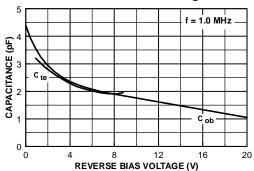




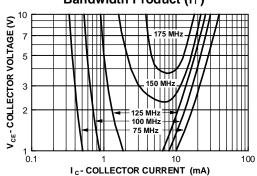
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#### Typical Characteristics (continued)

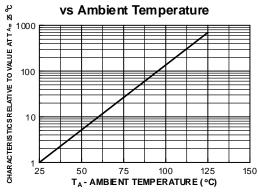




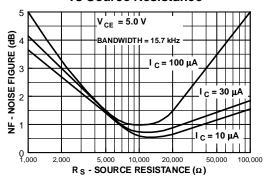
#### **Contours of Constant Gain** Bandwidth Product (f<sub>T</sub>)



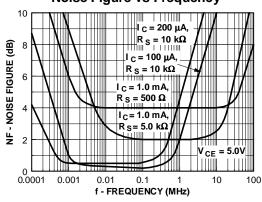
**Normalized Collector-Cutoff Current** vs Ambient Temperature



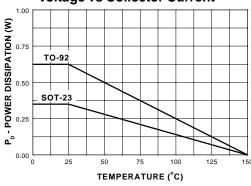
**Wideband Noise Frequency** vs Source Resistance



**Noise Figure vs Frequency** 



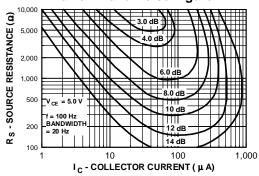
**Base-Emitter Saturation Voltage vs Collector Current** 



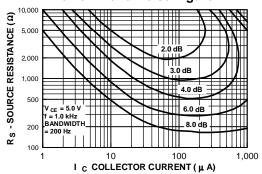
(continued)

#### Typical Characteristics (continued)

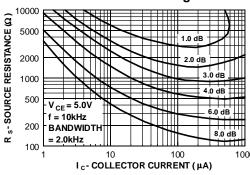
## Contours of Constant Narrow Band Noise Figure



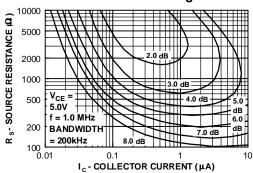
#### Contours of Constant Narrow Band Noise Figure



#### Contours of Constant Narrow Band Noise Figure



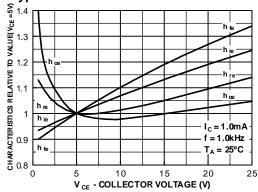
### **Contours of Constant Narrow Band Noise Figure**



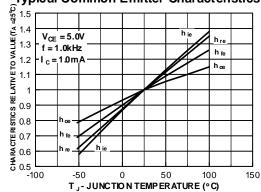
(continued)

#### **Typical Common Emitter Characteristics** (f = 1.0 kHz)

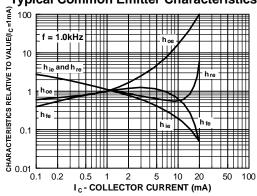
#### **Typical Common Emitter Characteristics**



#### **Typical Common Emitter Characteristics**



#### **Typical Common Emitter Characteristics**



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